

REV.	DESCRIPTION	DATE
B	舊樣具重開新樣具	2012/2/5

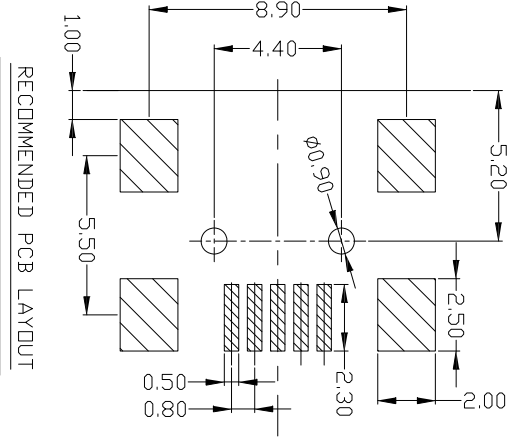
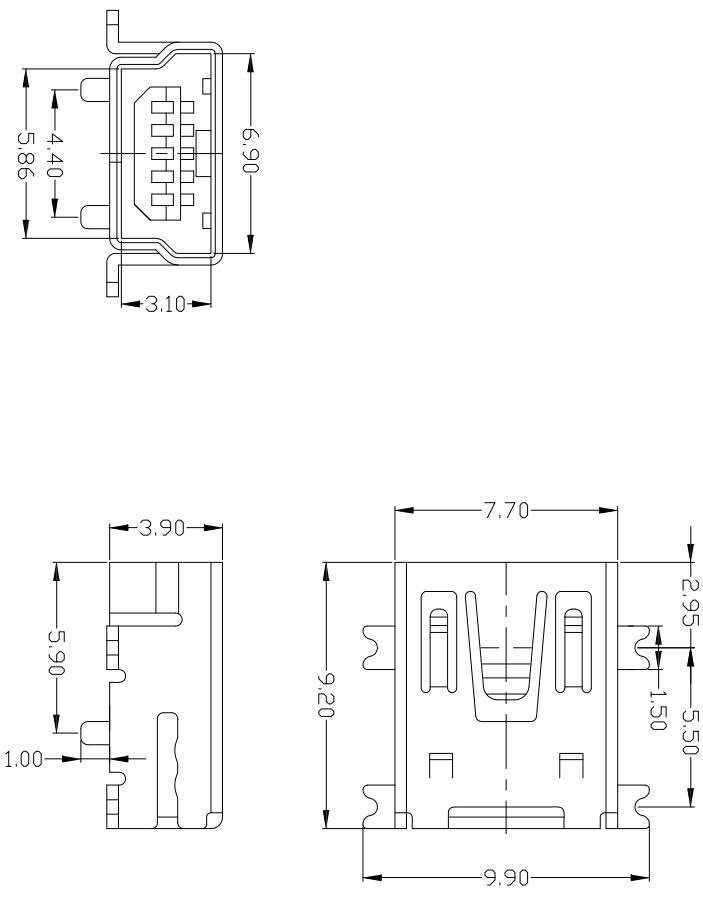
NOTE

Material:

- A. Insulator : High temp. plastic ,UL 94V-0 .
- B. Contact : Copper alloy
- C. Plating : Selective gold plated on contact area ; min 50u" Nickel plated all over ; min 100u" Sn on solder tail area.
- D. Shell : Copper Alloy,
- E. Shell Plating : Nickel Plated.

Electrical :

- A. Current : 1.0A max.
- B. Contact Resistance: 30mΩ maximum
- C. Insulation resistance: 100Ω minimum
- D. Dielectric withstanding voltage: 100V at sea level
- E. Temperature: -55°C to +105°C



RECOMMENDED PCB LAYOUT

<p>TOLERANCE</p> <p>X ±.30</p> <p>XX ±.25</p> <p>XXX ±.15</p>	<p>DRAWER</p> <p><i>Chuan Chuan Shu</i></p>	<p>NAME</p> <p>Mini-USB B type 5Pin Female SMD</p>
	<p>CHECK</p> <p><i>Shu Guang Shu</i></p>	
<p>UNITS : mm</p>	<p>DESIGNED</p> <p><i>Chuan Chuan Shu</i></p>	<p>SCALE</p> <p>4 : 1</p>
<p>APPROVAL</p> <p><i>Shu Guang Shu</i></p>	<p>DATE</p> <p>09 / 20 / 2009</p>	<p>PART NO.</p> <p>MSP-BR-5P-X</p>
<p>SCALE</p> <p>4 : 1</p>	<p>SIZE</p> <p>A4</p>	<p>DRWN NO.</p> <p>MSP-BR-5P</p>
<p>UNIT</p> <p>1 OF 1</p>	<p>REV.</p> <p>B</p>	<p>DATE</p> <p>2012/2/5</p>

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